

ADVANCE PROGRAM

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INTERNATIONAL CONFERENCE ON

SOLID STATE

DEVICES AND MATERIALS

Conference
Short Course
Place

September 22-24, 2010
September 21, 2010
The University of Tokyo
(Hongo Campus)
Tokyo Dome Hotel

Sponsored by
The Japan Society of Applied Physics
Technical-Cosponsored by
IEEE Electron Devices Society
in cooperation with

The Electrochemical Society of Japan

IEEE EDS Japan Chapter

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The logo for the Solid State Devices and Materials (SSDM) 2010 conference. It features a stylized grid pattern above the lowercase letters 'ssdm' in a bold, sans-serif font. Below 'ssdm' is the year '2010' in a similar bold, sans-serif font.

2010 International Conference on Solid State Devices and Materials (SSDM 2010)

SECRETARIAT

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